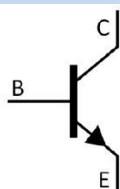


## / Descriptions

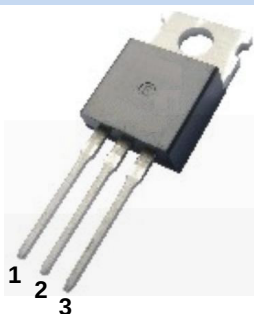
## / Features

## / Applications

## / Equivalent Circuit



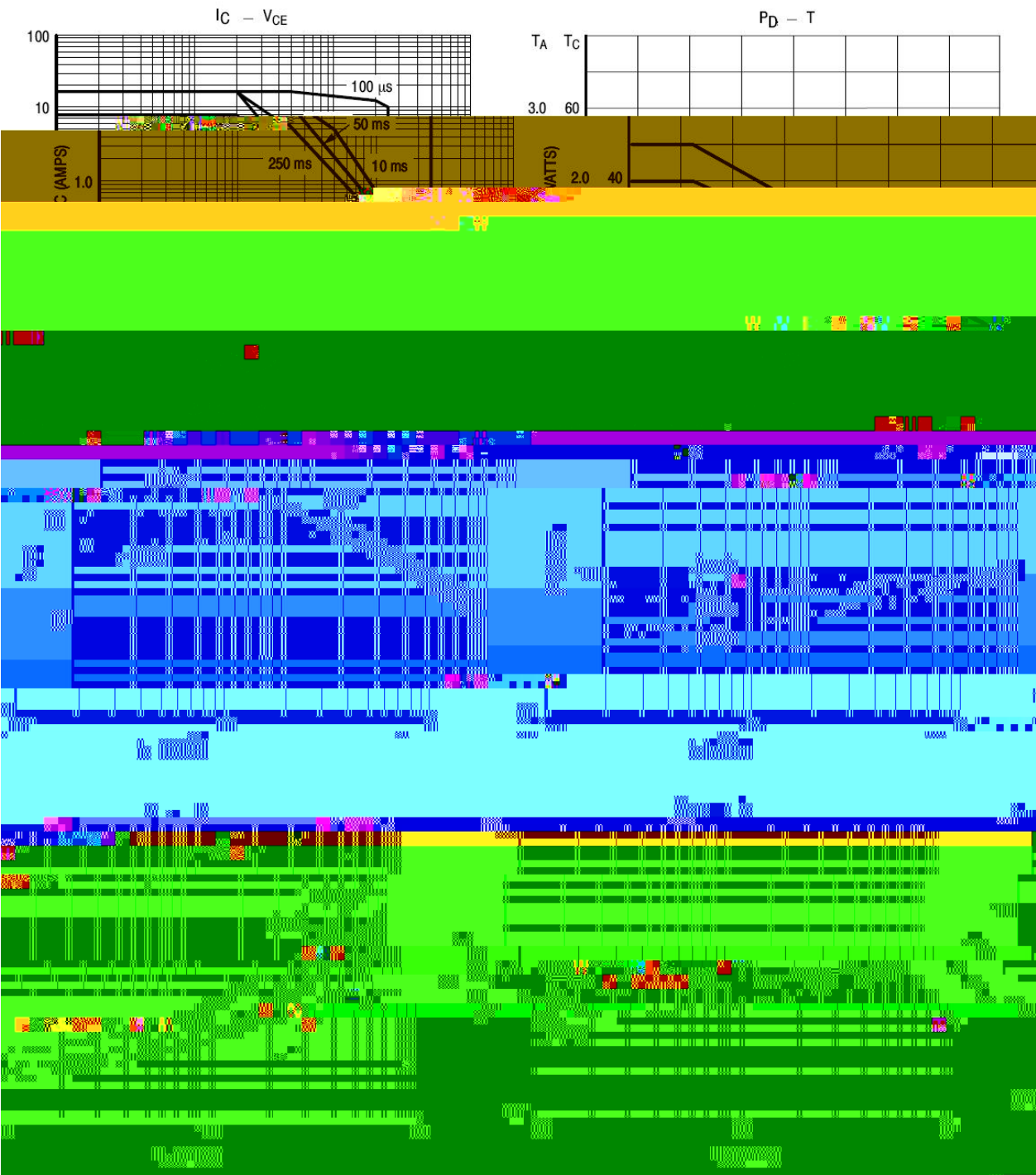
## / Pinning



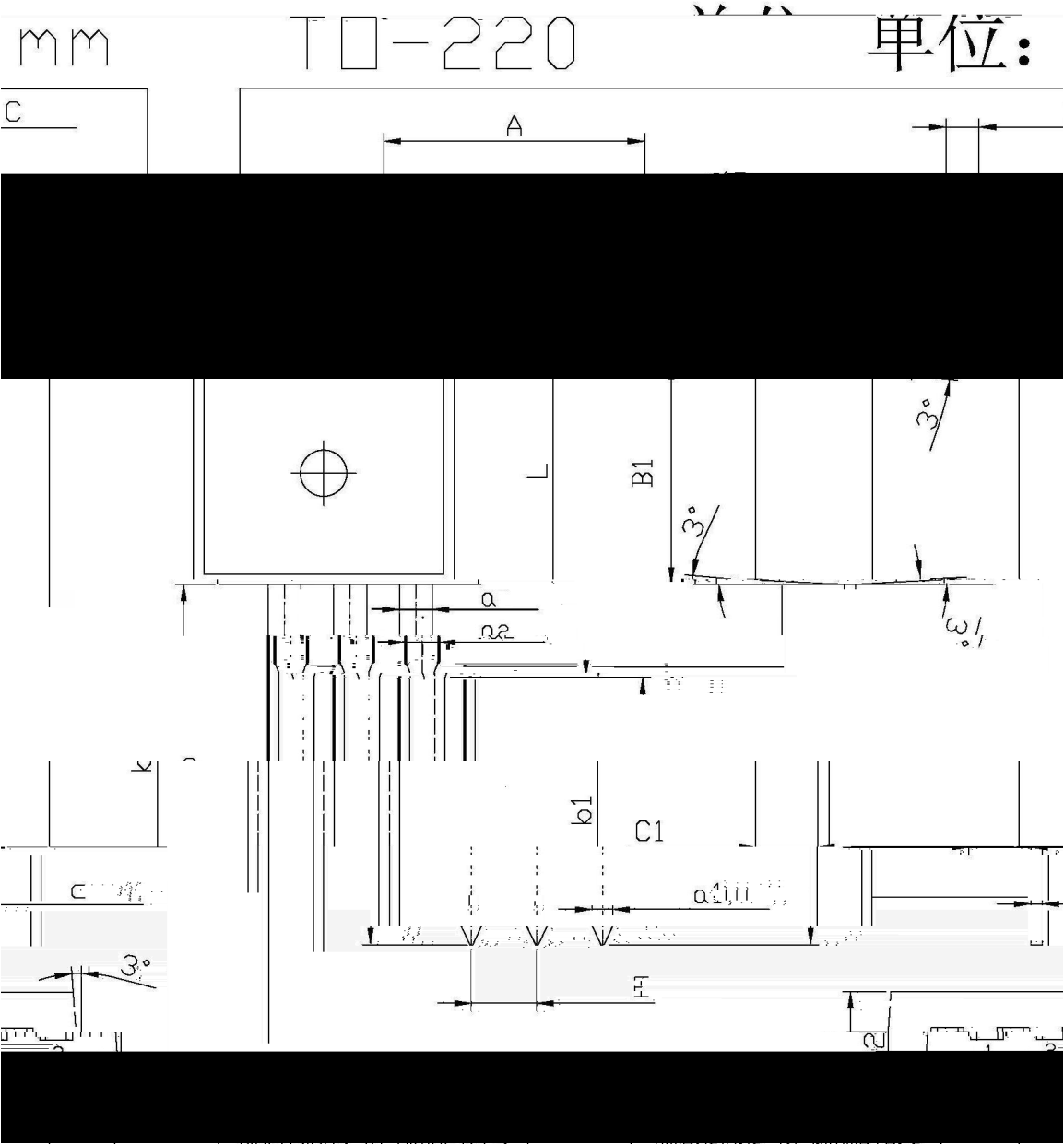
## / $h_{FE}$ Classifications & Marking

|  |   |  |  |
|--|---|--|--|
|  |   |  |  |
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|  |   |  |  |
|  | 0 |  |  |

/ Electrical Characteristic Curve

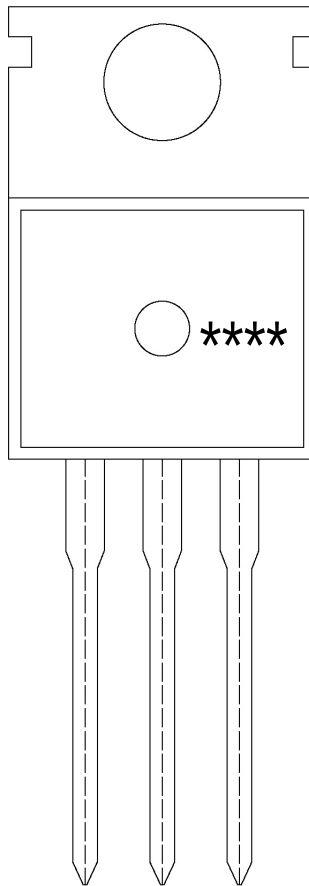


/ Package Dimensions

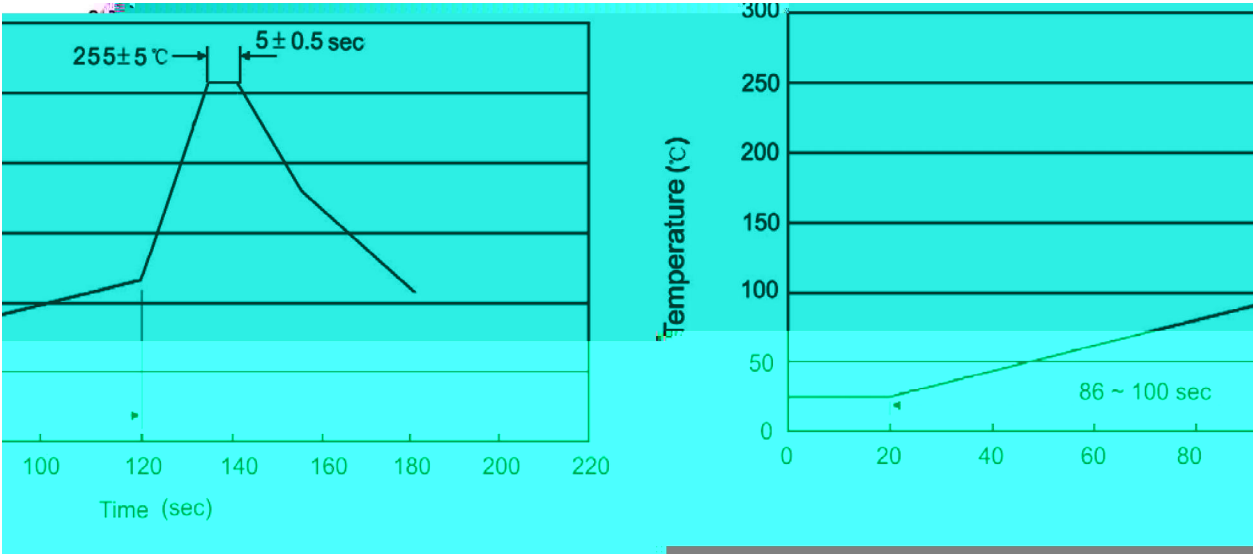


| Dimensions in Millimeters |      |      | Dimensions in Millimeters |      |      |
|---------------------------|------|------|---------------------------|------|------|
| Symbol                    | Min  | Max  | Symbol                    | Min  | Max  |
| A                         | 9.8  | 10.2 | C                         | 1.2  | 1.4  |
| B                         | 3.56 | 3.64 | B1                        | 6.3  | 6.7  |
| C1                        | 9.0  | 9.4  | F                         | 15.7 | 16.1 |
| a                         | 1.22 | 1.32 | a1                        | 0.4  | 0.6  |
| b1                        | 1.25 | 1.45 |                           |      |      |

/ Marking Instructions



(     ) / Temperature Profile for Dip Soldering(Pb-Free)



/ Resistance to Soldering Heat Test Conditions

/ Packaging SPEC.

| 封装形式 | 包装数量             |                       | 包装尺寸                   | : |
|------|------------------|-----------------------|------------------------|---|
|      | Units/Bag<br>只/袋 | Bags/Inner Box<br>袋/盒 | Units/Inner Box<br>只/盒 |   |